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Title	金属-半導体界面層あるいは絶縁体-半導体界面層を用い たAlGaN/GaNデバイスの閾値電圧制御
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Abstract

We have systematically investigated effects of metal-semiconductor or insulatorsemiconductor interfacial layers (ILs) in AlGaN/GaN devices, where AlO_x , TiO_x , or NiO_x is employed as an IL. From capacitance-voltage characteristics of metal/ IL/AlGaN/GaN devices with a metal-semiconductor IL between the gate metal and AlGaN, it is shown that the IL modulates the threshold voltage $V_{\rm th}$, attributed to the vacuum level step induced by the dipole of the IL. We find negative vacuum level steps for AlO_x and TiO_x ILs, and positive for NiO_x , from which the IL dipole density is estimated for each IL material. The two-dimensional electron gas carrier concentration in the metal/IL/AlGaN/GaN devices is also modulated by the vacuum level step. Furthermore, X-Ray photoelectron spectroscopy of the IL/AlGaN interfaces suggest a formation of NiGa in the $NiO_x/AlGaN$ interface. On the other hand, from capacitance-voltage characteristics of metal/Al₂O₃/IL/AlGaN/GaN devices with an insulator-semiconductor IL between Al_2O_3 and AlGaN, the fixed charge density of the $Al_2O_3/IL/AlGaN$ interface is evaluated by the Al_2O_3 thickness dependence of V_{th} . For AlO_x and TiO_x ILs, the fixed charge density is higher than that of the $Al_2O_3/AlGaN$ interface with no IL, while lower for NiO_x . The fixed charge density for an IL shows a positive correlation with the IL dipole density, suggesting that the fixed charge is related to the unbalanced IL dipole. Furthermore, using the conductance method, we find a low trap density of the $Al_2O_3/IL/AlGaN$ interface for AlO_x and NiO_x ILs, in comparison with that of the $Al_2O_3/AlGaN$ interface with no IL.

Keywords: AlGaN/GaN device, interfacial layer, threshold voltage control, vacuum level step, fixed charge